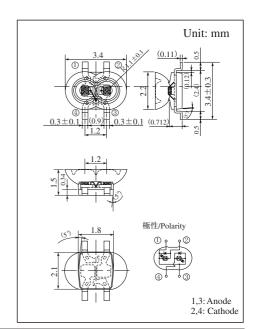
Surface Mounting Chip LED

Strobe Type

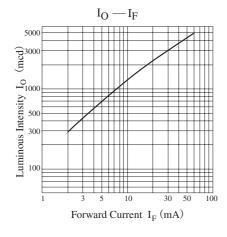
■ Absolute Maximum Ratings (T_a=25±3°C)

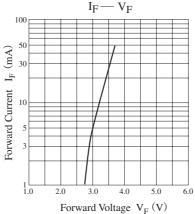
Lighting Color	P(mW)	I _{FDC} (mA)	I _{FP} (mA)	I _{RDC} (mA)	T _{opr} (°C)	T _{stg} (°C)
White	103	25	50	100	-30~+85	-40~+100

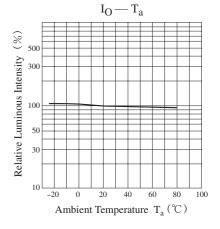


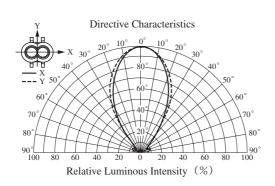
■Main Specification (T_a=25 °C)

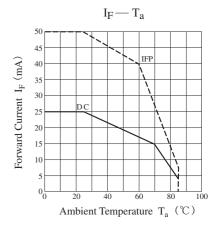
Item	Symbol	Condition	Тур	Limit		Unit
nem		Condition		Min	Max	Offic
Forward Voltage	$V_{\rm F}$	I _{FDC} =20mA/chip	3.4	3.0	4.0	V
Luminous Intensity	I _{O-20}	I _{FDC} = 20mA/chip	2000	1500	_	mcd
Chromaticity coordinates	X	I _{FDC} = 20mA/chip	_	0.280	0.340	_
Chromaticity coordinates	У	I _{FDC} = 20 mA/chip	_	0.260	0.410	_











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